

PROTECTION PRODUCTS - Z-Pak™

Description

μ Clamp[®] TVS diodes are designed to protect sensitive electronics from damage or latch-up due to ESD. They are designed to replace 0201 size multilayer varistors (MLVs) in portable applications such as cell phones, notebook computers, and other portable electronics. They feature large cross-sectional area junctions for conducting high transient currents. These devices offer desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

The μ Clamp[®]1211Z is in a 2-pin SLP0603P2X3 package. It measures 0.6 x 0.3 mm with a nominal height of only 0.25mm. The leads are finished with lead-free NiPdAu. Each device will protect one line operating at 12 volts. It gives the designer the flexibility to protect single lines in applications where arrays are not practical. The combination of small size and high ESD surge capability makes them ideal for use in portable applications such as cellular phones, digital cameras, and tablet PC's.

Features

- ◆ High ESD withstand Voltage: +/-**30kV** (Contact/Air) per **IEC 61000-4-2**
- ◆ Able to withstand over 1000 ESD strikes per IEC 61000-4-2 Level 4
- ◆ Ultra-small **0201 package**
- ◆ Protects one data or power line
- ◆ Low reverse current: <50nA (VR=12V)
- ◆ Working voltage: +/- 12V
- ◆ Low capacitance: 25pF maximum
- ◆ Solid-state silicon-avalanche technology

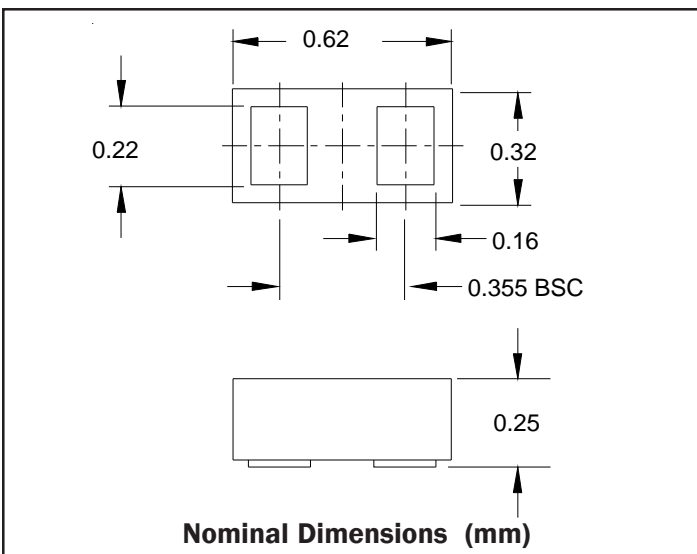
Mechanical Characteristics

- ◆ SLP0603P2X3 package
- ◆ Pb-Free, Halogen Free, RoHS/WEEE Compliant
- ◆ Nominal Dimensions: 0.6 x 0.3 x 0.25 mm
- ◆ Lead Finish: NiPdAu
- ◆ Marking : Marking code + dot matrix date code
- ◆ Packaging : Tape and Reel

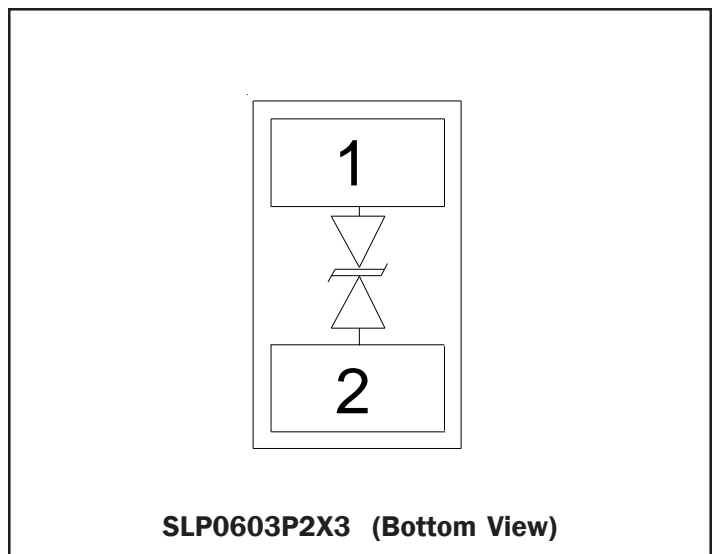
Applications

- ◆ Cellular Handsets & Accessories
- ◆ Portable Instrumentation
- ◆ 12V Power Protection
- ◆ Tablet PC

Nominal Dimensions



Schematic



PROTECTION PRODUCTS

Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	P_{pk}	125	Watts
Maximum Peak Pulse Current (tp = 8/20μs)	I_{pp}	5	Amps
ESD per IEC 61000-4-2 (Air) ¹ ESD per IEC 61000-4-2 (Contact) ¹	V_{ESD}	+/- 30 +/- 30	kV
Operating Temperature	T_J	-55 to +125	°C
Storage Temperature	T_{STG}	-55 to +150	°C

Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}	Pin 1 to 2 or 2 to 1			12	V
Reverse Breakdown Voltage	V_{BR}	$I_t = 1mA$ Pin 1 to 2 or 2 to 1	13.3	16	19	V
Reverse Leakage Current	I_R	$V_{RWM} = 12V, T=25°C$ Pin 1 to 2 or 2 to 1		<10	50	nA
Clamping Voltage	V_C	$I_{pp} = 1A, tp = 8/20μs$ Pin 1 to 2 or 2 to 1			20	V
Clamping Voltage	V_C	$I_{pp} = 5A, tp = 8/20μs$ Pin 1 to 2 or 2 to 1			25	V
Dynamic Resistance ^{2, 3}	R_{DYN}	tlp = 0.2 / 100ns		0.30		Ohms
Junction Capacitance	C_J	$V_R = 0V, f = 1MHz$		19	25	pF

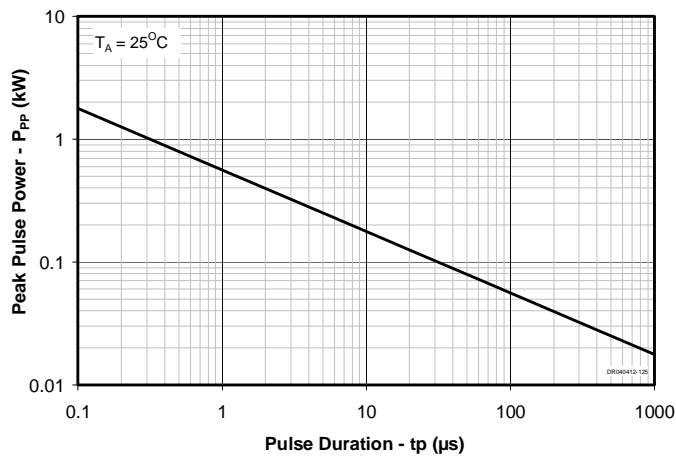
Notes

- 1)ESD gun return path connected to ESD ground reference plane.
- 2)Transmission Line Pulse Test (TLP) Settings: $t_p = 100ns$, $t_r = 0.2ns$, I_{TLP} and V_{TLP} averaging window: $t_1 = 70ns$ to $t_2 = 90ns$.
- 3) Dynamic resistance calculated from $I_{TLP} = 4A$ to $I_{TLP} = 16A$

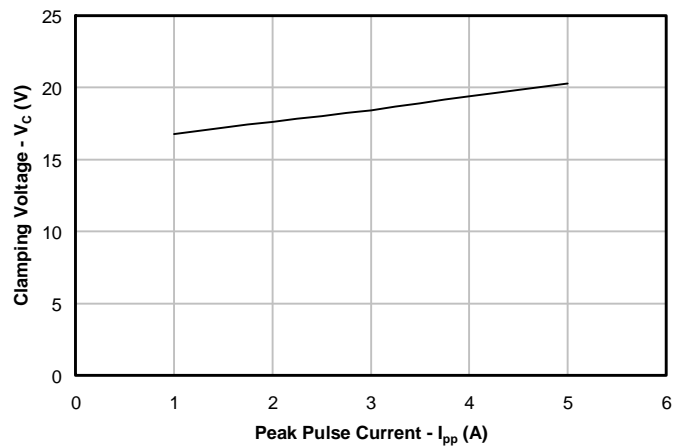
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Typical Characteristics

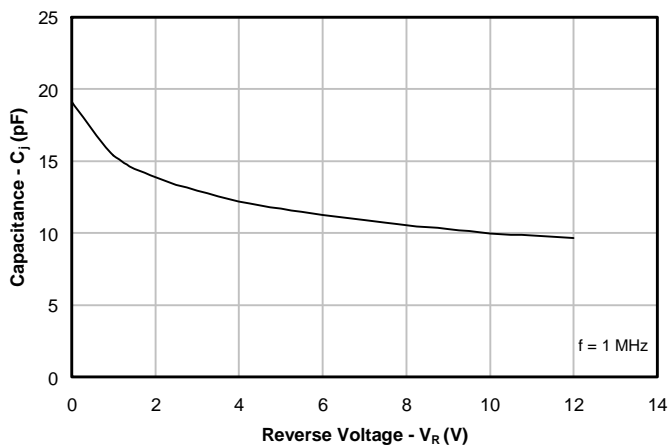
Non-Repetitive Peak Pulse Power vs. Pulse Time



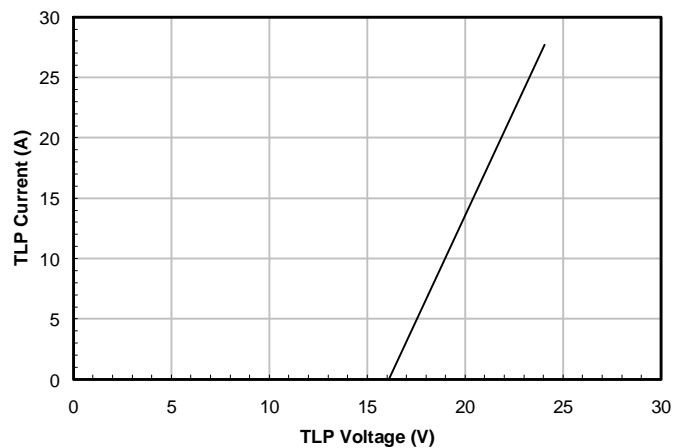
Clamping Voltage vs. Peak Pulse Current (t_p=8/20us)



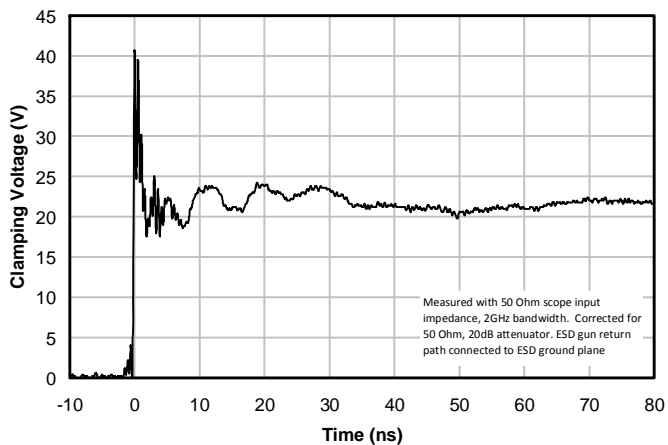
Junction Capacitance vs. Reverse Voltage



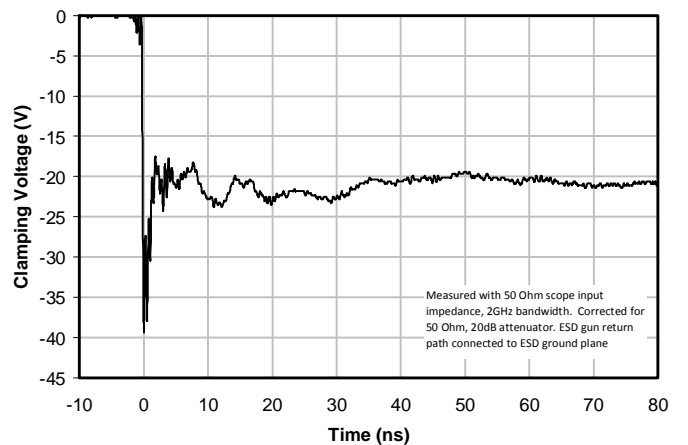
TLP Characteristic



ESD Clamping (+8kV Contact per IEC 61000-4-2)



ESD Clamping (-8kV Contact per IEC 61000-4-2)



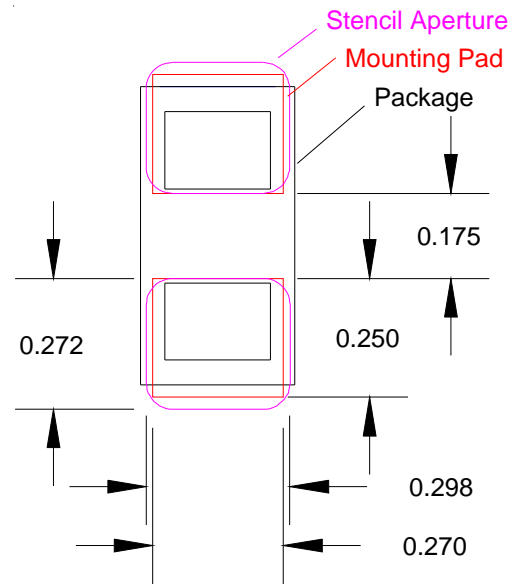
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Applications Information

Assembly Guidelines

The small size of this device means that some care must be taken during the mounting process to insure reliable solder joint. The table below provides Semtech's recommended assembly guidelines for mounting this device. The figure at the right details Semtech's recommended aperture based on the below recommendations. Note that these are only recommendations and should serve only as a starting point for design since there are many factors that affect the assembly process. The exact manufacturing parameters will require some experimentation to get the desired solder application.

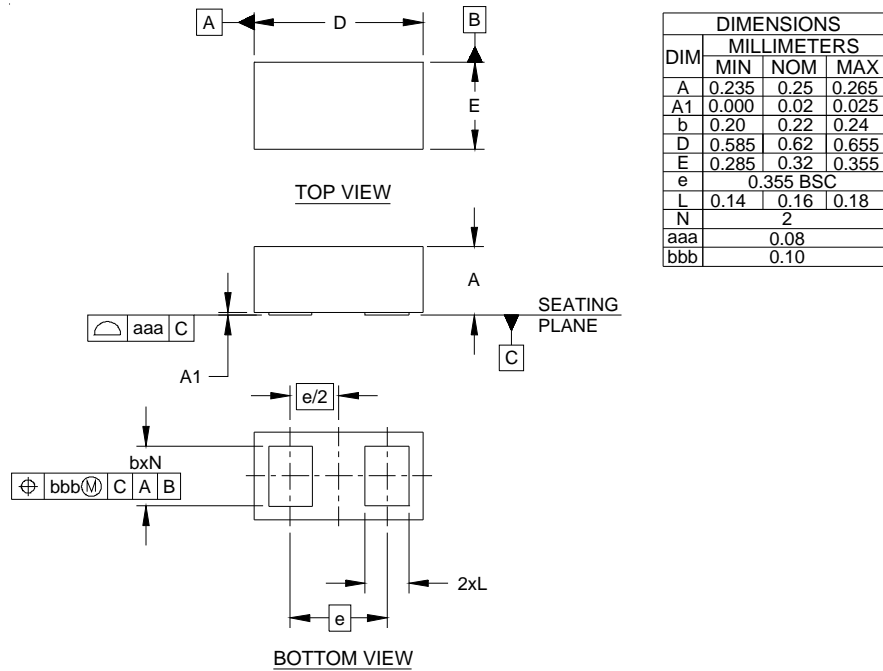
Assembly Parameter	Recommendation
Solder Stencil Design	Laser cut, Electro-polished
Aperture shape	Rectangular with rounded corners
Solder Stencil Thickness	0.100 mm (0.004")
Solder Paste Type	Type 4 size sphere or smaller
Solder Reflow Profile	Per JEDEC J-STD-020
PCB Solder Pad Design	Non-Solder mask defined
PCB Pad Finish	OSP OR NiAu



Recommended Mounting Pattern

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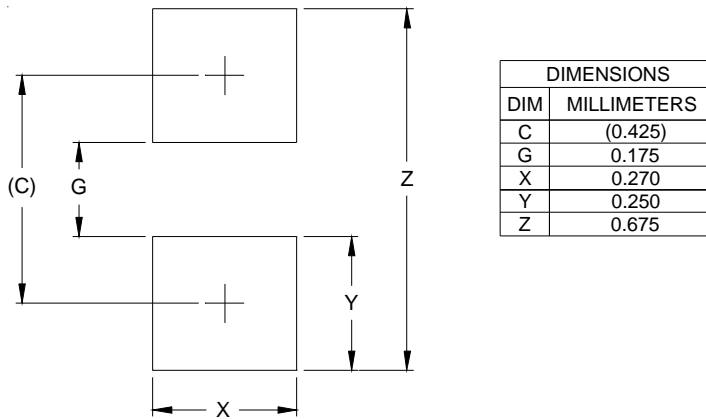
Outline Drawing - SLP0603P2X3



DIM	MILLIMETERS		
	MIN	NOM	MAX
A	0.235	0.25	0.265
A1	0.000	0.02	0.025
b	0.20	0.22	0.24
D	0.585	0.62	0.655
E	0.285	0.32	0.355
e	0.355 BSC		
L	0.14	0.16	0.18
N	2		
aaa	0.08		
bbb	0.10		

NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

Land Pattern - SLP0603P2X3

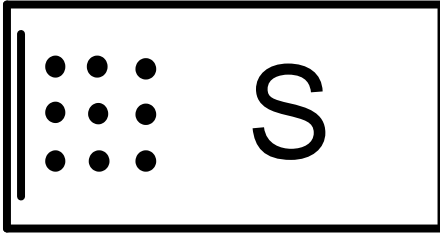


DIMENSIONS	
DIM	MILLIMETERS
C	(0.425)
G	0.175
X	0.270
Y	0.250
Z	0.675

NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY.
CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

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Marking Code



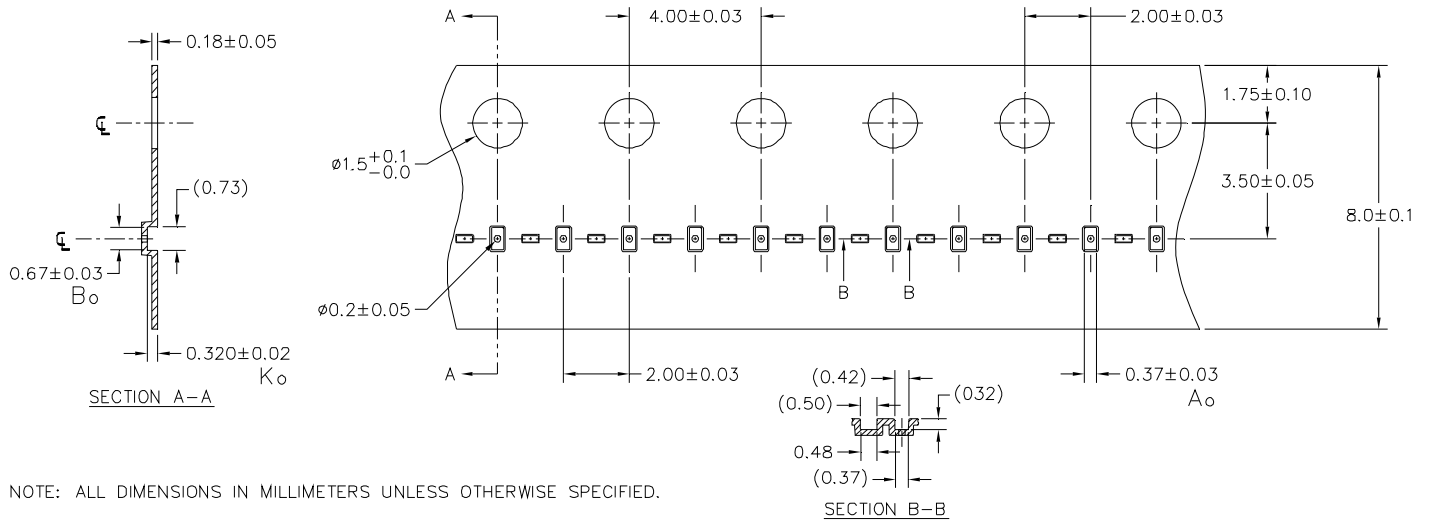
Notes:
Marking will also include dot matrix date code

Ordering Information

Part Number	Qty per Reel	Reel Size
uClamp1211Z.TNT	10,000	7 Inch

Notes:
MicroClamp, uClamp and μ Clamp are trademarks of Semtech Corporation

Carrier Tape Specification

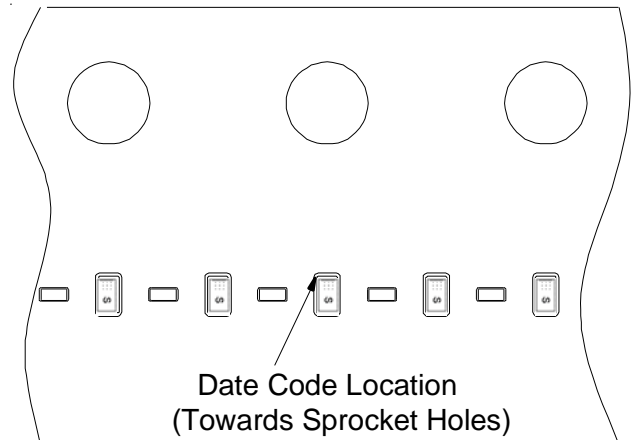


NOTE: ALL DIMENSIONS IN MILLIMETERS UNLESS OTHERWISE SPECIFIED.

A0	B0	K0
0.37 +/-0.03 mm	0.67 +/-0.03 mm	0.32 +/-0.02 mm

Note: All dimensions in mm unless otherwise specified

Device Orientation in Tape



Contact Information

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